TOSHIBA Photocoupler Photorelay

TLP172G

Modem·Fax Cards, Modems in PC

Telecommunications

PBX

Measurement Equipment

The Toshiba TLP172G consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

The TLP172G is suitable for the modem applications which require space savings. $\,$

• 4-pin SOP (2.54SOP4): Height = 2.1 mm, Pitch = 2.54 mm

• 1-Form-A

• Peak Off-state voltage: 350 V (min)

• Trigger LED current: 3 mA (max)

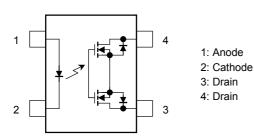
• On-state current: 110 mA (max)

• On-state resistance: 35Ω (max t < 1 s)

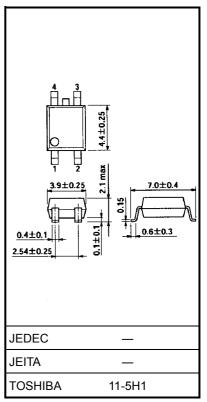
• On-state resistance: 50Ω (max continuous)

• Isolation voltage: 1500 Vrms (min)

Pin Configuration (top view)



Unit: mm



Weight: 0.1 g (typ.)

Maximum Rating (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
	Forward current	l _F	50	mA	
	Forward current derating (Ta ≧ 25°C)	ΔI _F /°C	-0.5	mA/°C	
LED	Reverse voltage	V_{R}	5	٧	
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage	V _{OFF}	350	V	
	On-state current	I _{ON}	110	mA	
Detector	On-state current derating (Ta ≧ 25°C)	Δl _{ON} /°C	-1.1	mA/°C	
	Junction temperature	Tj	125	°C	
Storage temperature range		T _{stg}	-55~125	°C	
Operating temperature range		T _{opr}	-40~85	°C	
Lead soldering temperature (10 s)		T _{sol}	260	°C	
Isolation voltage (AC, 1 min, R.H. ≦ 60%) (Note 1)		BVS	1500	Vrms	

Note 1: Device considered a two-terminal device: LED side pins shorted together, and detector side pins shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{DD}			280	٧
Forward current	I _F	5	7.5	25	mA
On-state current	I _{ON}	_	_	100	mA
Operating temperature	T _{opr}	-20	_	65	°C

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	C _T	V = 0, f = 1 MHz	_	30	_	pF
Detector	Off-state current	l _{OFF}	V _{OFF} = 350 V	_	_	1	μΑ
Detector	Capacitance	C _{OFF}	V = 0, f = 1 MHz	_	30	_	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	I _{ON} = 110 mA	_	1	3	mA
Return LED current	I _{FC}	I _{OFF} = 100 μA	0.1		_	mA
On-state resistance	R _{ON}	$I_{ON} = 110 \text{ mA}, I_{F} = 5 \text{ mA}, t < 1 \text{ s}$	_	25	35	Ω
	TON	$I_{ON} = 110 \text{ mA}, I_F = 5 \text{ mA}, \text{ continuous}$		35	50	22

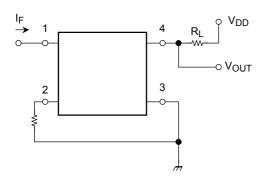
Isolation Characteristics (Ta = 25°C)

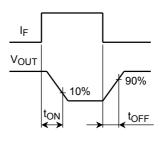
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≦ 60%	5×10^{10}	10 ¹⁴	_	Ω
		AC, 1 min	1500	_	_	Vrms
Isolation voltage	BV_S	AC, 1 s, in oil 3000	3000	_	VIIIIS	
		DC, 1 min, in oil	_	3000	_	Vdc

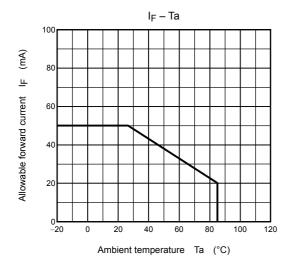
Switching Characteristics (Ta = 25°C)

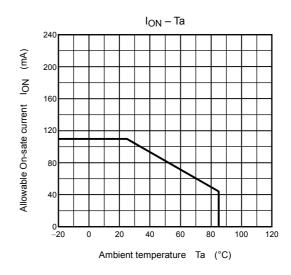
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	$R_L = 200 \Omega$	_	0.3	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V}, I_F = 5 \text{ mA}$ (Note 2)	_	0.1	1	1113

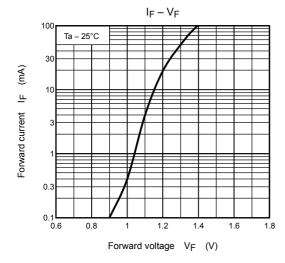
Note 2: Switching time test circuit

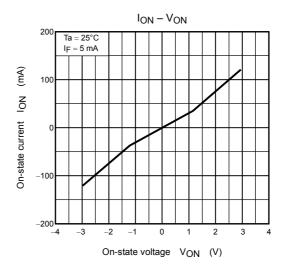


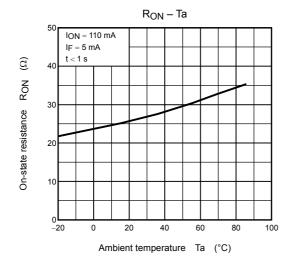


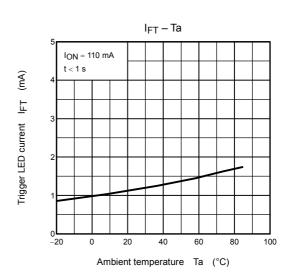


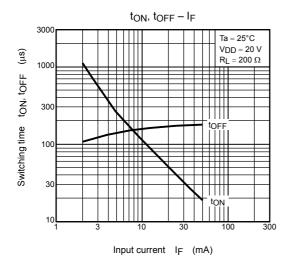


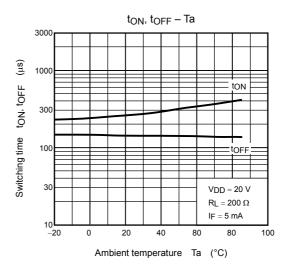


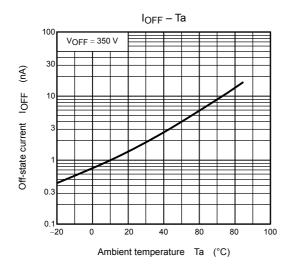












5

RESTRICTIONS ON PRODUCT USE

000707EBC

- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes
 are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the
 products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with
 domestic garbage.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
- The information contained herein is presented only as a guide for the applications of our products. No
 responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other
 rights of the third parties which may result from its use. No license is granted by implication or otherwise under
 any intellectual property or other rights of TOSHIBA CORPORATION or others.
- The information contained herein is subject to change without notice.